



# **Product Change Notification**

## **113602 - 00**

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# Product Change Notification

**Change Notification #:** 113602 - 00  
**Change Title:** Intel® SSD DC P3600 Series (1.2TB, 1.6TB, 2.0TB 1/2 Height PCIe 3.0, 20nm, MLC), Intel® SSD DC P3600 Series (400GB, 800GB, 1/2 Height PCIe 3.0, 20nm, MLC), Intel® SSD DC P3700 Series (1.6TB, 2.0TB, 1/2 Height PCIe 3.0, 20nm, MLC), Intel® SSD DC P3700 Series (400GB, 800GB, 2.0, 1/2 Height PCIe 3.0, 20nm, MLC)  
**PCN 113602-00**  
**Product Material**  
**Second Source Supplier**

**Date of Publication:** January 30, 2015

## Key Characteristics of the Change:

Product Material

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	February 13, 2015
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## Description of Change to the Customer:

Intel is changing the nameplate on the Intel® SSD DC P3700 and DC P3600 Series. The change includes sourcing from an additional manufacturer. The change includes the new Intel owned font, Intel Clear, to improve readability, along with the increased font size. The nameplate on the bottom is the updated version.



Rendering of new nameplate for Intel® SSD DC P3600 Series.



**Customer Impact of Change and Recommended Action:**

Intel does not anticipate any customer impact with the change of the nameplate. The notification is for protection from fraudulent or counterfeit products, and is informative only.

Milestone dates are estimates and subject to change based on business and operational conditions.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#
SSDPEDMD400G401	933088
SSDPEDMD800G401	933089
SSDPEDMD016T401	933090
SSDPEDMD020T401	933091
SSDPEDME400G401	934675
SSDPEDME800G401	934676
SSDPEDME012T401	934677
SSDPEDME016T401	934678
SSDPEDME020T401	934679
SSDPEDMD400G410	937364
SSDPEDMD800G410	937365
SSDPEDMD016T410	937366
SSDPEDMD020T410	937367
SSDPEDME400G410	937374
SSDPEDME800G410	937375
SSDPEDME012T410	937376
SSDPEDME016T410	937377
SSDPEDME020T410	937378

**PCN Revision History:**

**Date of Revision:**  
January 30, 2015

**Revision Number:**  
00

**Reason:**  
Originally Published PCN